# Onsemi

# **MOSFET** – Single P-Channel, Small Signal, SOT-1123, 1.0 x 0.6 mm -20 V, -200 mA

# NTNUS3171PZ

#### Features

- Single P–Channel MOSFET
- Offers a Low R<sub>DS(on)</sub> Solution in the Ultra Small 1.0 x 0.6 mm Package
- 1.5 V Gate Voltage Rating
- Ultra Thin Profile (< 0.5 mm) Allows It to Fit Easily into Extremely Thin Environments such as Portable Electronics.
- This is a Pb–Free Device

#### Applications

- High Side Switch
- High Speed Interfacing
- Optimized for Power Management in Ultra Portable Equipment

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise specified)

• Optimized for Power Management in Ultra Portable Equipment							
MAXIMUM RATINGS (T <sub>J</sub> = 25°C unless otherwise specified)							
Para	meter		Symbol	Value	Unit	2	
Drain-to-Source Voltag	je		V <sub>DSS</sub>	-20	(V)	2	
Gate-to-Source Voltag	e		V <sub>GS</sub>	±8	V	O.	
Continuous Drain	Steady	T <sub>A</sub> = 25°C		-150	K	]	
Current (Note 1)	State	T <sub>A</sub> = 85°C	ΙD	-110	mA		
	t ≤ 5 s	T <sub>A</sub> = 25°C	2.2	-200			
Power Dissipation	Steady	ol F	SE	-125		]	
(Note 1)	State	T <sub>A</sub> = 25°C	PD		mW		
	t ≤ 5 s			-200			
Pulsed Drain Current	\$	t <sub>p</sub> = 10 μs	I <sub>DM</sub>	-600	mA		
Operating Junction and Storage Temperature		T <sub>J</sub> ,	–55 to 150	°C			
			T <sub>STG</sub>	150			
Source Current (Body Diode) (Note 2)		۱ <sub>S</sub>	-200	mA			
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		TL	260	°C			
						-	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Surface-mounted on FR4 board using the minimum recommended pad size, or 2 mm<sup>2</sup>, 1 oz Cu.
- 2. Pulse Test: pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2%

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> Max
	3.5 Ω @ –4.5 V	
–20 V	4.0 Ω @ –2.5 V	0.00.4
	5.5 Ω @ –1.8 V	–0.20 A
	7.0 Ω @ –1.5 V	

SOT-1123

CASE 524AA

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MARKING DIAGRAM

Specific Device Code (Rotated 90° Clockwise)



P-Channel MOSFET

> D 0 3

#### **ORDERING INFORMATION**

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Device	Package	Shipping <sup>†</sup>
NTNUS3171PZT5G	SOT-1123 (Pb-Free)	8000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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#### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Unit
Junction-to-Ambient – Steady State (Note 3)	$R_{\theta JA}$	1000	°C/W
Junction-to-Ambient – t = 5 s (Note 3)	$R_{ hetaJA}$	600	

3. Surface-mounted on FR4 board using the minimum recommended pad size, or 2 mm<sup>2</sup>, 1 oz Cu.

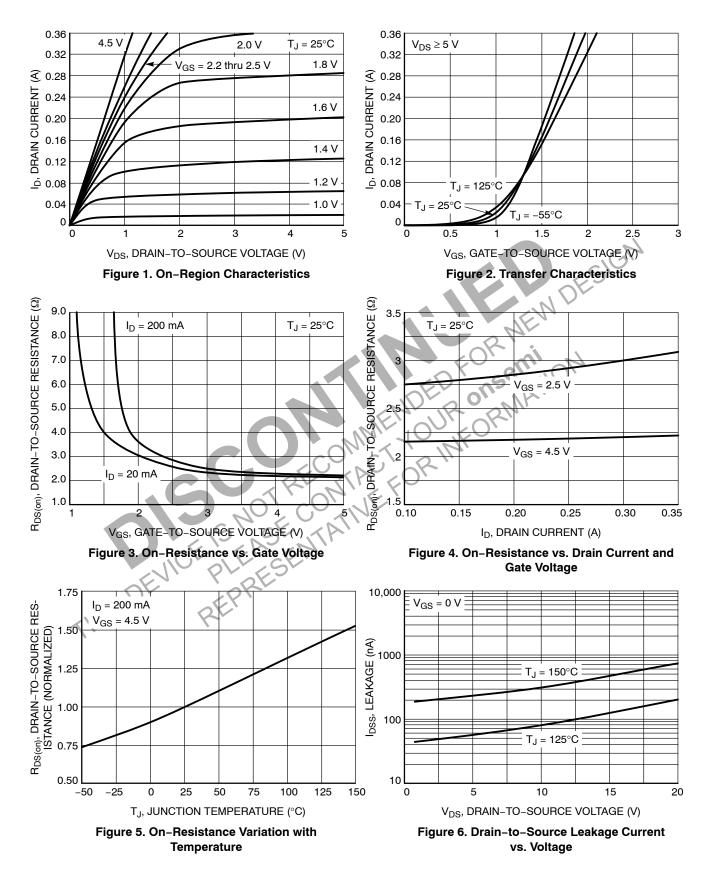
#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

Parameter	Symbol	Test Conditio	on	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•						
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}~=~0$ V, $I_{D}=-250~\mu A$		-20			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS}$ = 0 V, $V_{DS}$ = -5.0 V	$T_J = 25^{\circ}C$			-50	
		$V_{GS}$ = 0 V, $V_{DS}$ = -5.0 V	$T_J = 85^{\circ}C$			-100	nA
		$V_{GS}$ = 0 V, $V_{DS}$ = -16 V	T <sub>J</sub> = 25°C			-200	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = :	<u>±</u> 5.0 V			±100	nA
ON CHARACTERISTICS (Note 4)					20	$\sim$	
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D = -2$	250 μΑ	-0.4	+0.7	-1.0	V
Drain-to-Source On Resistance	R <sub>DS(ON)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -$	-100 mA	SU.	2.0	3.5	
		$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -2.5 \text{ V}$	-50 mA		2.6	4.0	
		V <sub>GS</sub> = -1.8 V, I <sub>D</sub> = -	-20 mA		3.4	5.5	Ω
		V <sub>GS</sub> = -1.5 V, I <sub>D</sub> = -	10 mA	15	4.0	7.0	
		V <sub>GS</sub> = -1.2 V, I <sub>D</sub> = -	-1.0 mA	7	6.0		
Forward Transconductance	9FS	V <sub>DS</sub> = -5.0 V, I <sub>D</sub> = -	125 mA		0.26		S
Source-Drain Diode Voltage	V <sub>SD</sub>	$V_{GS} = 0 V, 1_{S} = -20$	00 mA	-0.5		-1.4	V
CHARGES, CAPACITANCES AND GATE R	ESISTANCE						
Input Capacitance	C <sub>ISS</sub>	TH FOU			13		
Output Capacitance	C <sub>OSS</sub>	f = 1 MHz, V <sub>GS</sub> = 0 V V <sub>DS</sub> = -15 V			3.4		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>				1.6		
Total Gate Charge	Q <sub>G(TOT)</sub>				0.7		
Threshold Gate Charge	Q <sub>G(TH)</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 15 V; I <sub>D</sub> = 200 mA			0.1		nC
Gate-to-Source Charge	Q <sub>GS</sub>				0.2		
Gate-to-Drain Charge	Q <sub>GD</sub>			0.1			
SWITCHING CHARACTERISTICS, $V_{GS} = 4$ .	5 V (Note 4)						
Turn-On Delay Time	t <sub>d(ON)</sub>	$V_{GS}$ = -4.5 V, $V_{DD}$ = -15 V, $I_{D}$ = -200 mA, $R_{G}$ = 2.0 $\Omega$			30		ns
Rise Time	t <sub>r</sub>				56		
Turn–Off Delay Time	t <sub>d(OFF)</sub>				196		
Fall Time	t <sub>f</sub>				145		

4. Switching characteristics are independent of operating junction temperatures

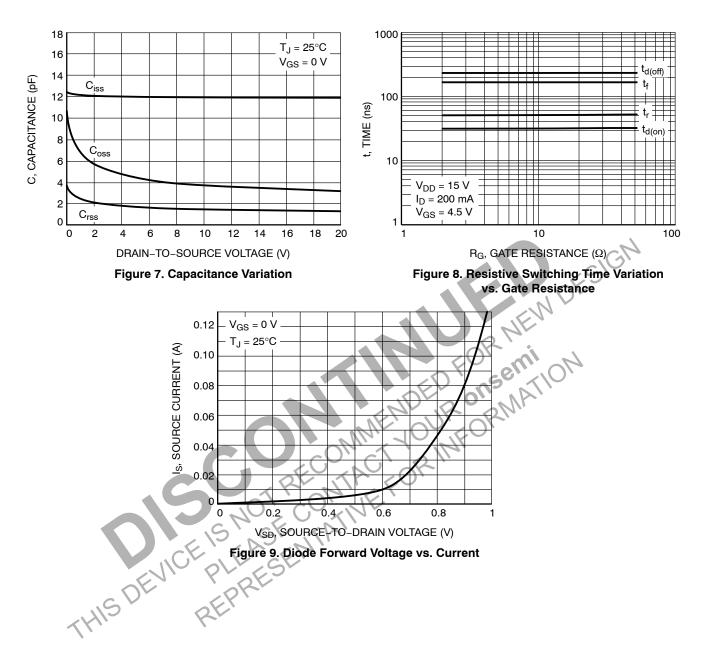
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#### **TYPICAL CHARACTERISTICS**

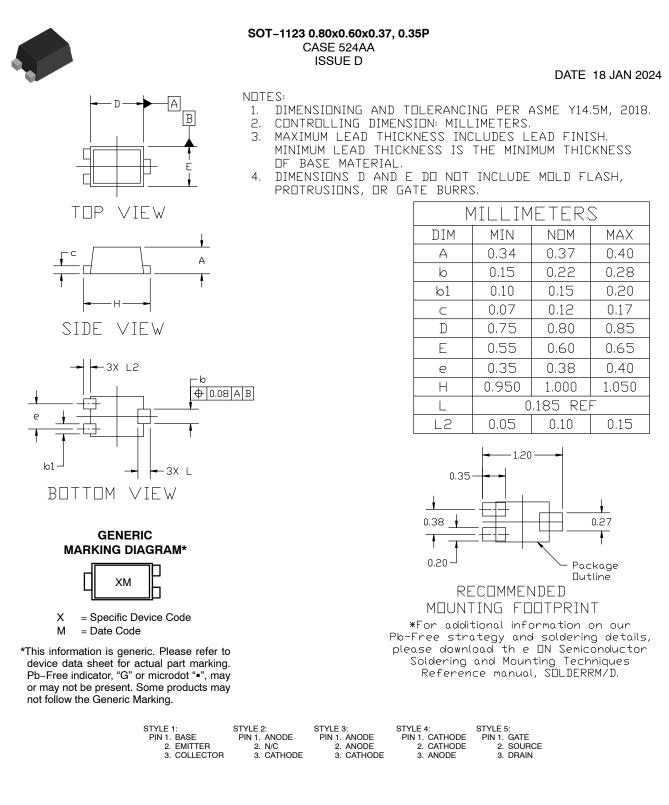


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#### **TYPICAL CHARACTERISTICS**







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DESCRIPTION:	SOT-1123 0.80x0.60x0.37, 0.35P		PAGE 1 OF 1	

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